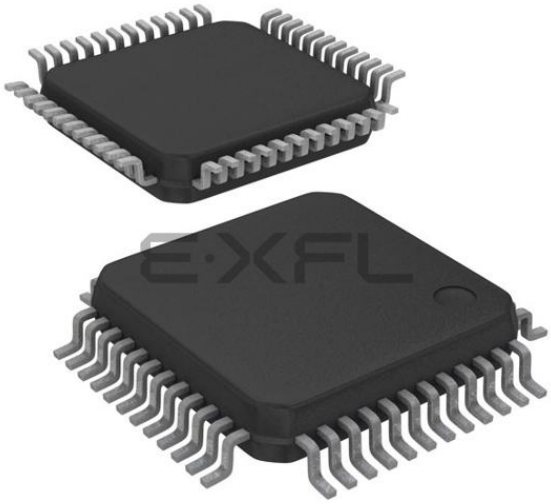
Renesas Electronics America Inc - R5F52306ADFL#30 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	54MHz
Connectivity	I²C, IrDA, SCI, SPI, SSI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	34
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LFQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f52306adfl-30

Table 1.1 Outline of Specifications (3/4)

Classification	Module/Function	Description
Timers	Independent watchdog timer (IWDTa)	• 14 bits × 1 channel • Count clock: Dedicated low-speed on-chip oscillator for the IWDT Frequency divided by 1, 16, 32, 64, 128, or 256
	Realtime clock (RTCe)	• Clock source: Sub-clock • Time/calendar • Interrupts: Alarm interrupt, periodic interrupt, and carry interrupt • Time-capture facility for three values
	Low power timer (LPT)	• 16 bits × 1 channel • Clock source: Sub-clock, Dedicated low-speed on-chip oscillator for the IWDT Frequency divided by 2, 4, 8, 16, or 32
	8-bit timer (TMR)	• (8 bits × 2 channels) × 2 units • Seven internal clocks (PCLK/1, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, and PCLK/8192) and an external clock can be selected • Pulse output and PWM output with any duty cycle are available • Two channels can be cascaded and used as a 16-bit timer
Communication functions	Serial communications interfaces (SCIg, SCIh)	• 7 channels (channel 0, 1, 5, 6, 8, 9: SCIg, channel 12: SCIh) • SCIg Serial communications modes: Asynchronous, clock synchronous, and smart-card interface Multi-processor function On-chip baud rate generator allows selection of the desired bit rate Choice of LSB-first or MSB-first transfer Average transfer rate clock can be input from TMR timers for SCI5, SCI6, and SCI12 Start-bit detection: Level or edge detection is selectable. Simple I^2C Simple SPI 9-bit transfer mode Bit rate modulation Event linking by the ELC (only on channel 5) • SCIh (The following functions are added to SCIg) Supports the serial communications protocol, which contains the start frame and information frame Supports the LIN format
	IrDA interface (IRDA)	• 1 channel (SCI5 used) • Supports encoding/decoding of waveforms conforming to IrDA standard 1.0
	I^2C bus interface (RIICa)	• 1 channel • Communications formats: I^2C bus format/SMBus format • Master mode or slave mode selectable • Supports fast mode
	Serial peripheral interface (RSPIa)	• 1 channel • Transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) • Capable of handling serial transfer as a master or slave • Data formats • Choice of LSB-first or MSB-first transfer The number of bits in each transfer can be changed to 8, 9, 10, 11, 12, 13, 14, 15, 16, 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Double buffers for both transmission and reception
	USB 2.0 host/function module (USBd)	• USB Device Controller (UDC) and transceiver for USB 2.0 are incorporated. • Host/function module: 1 port • Compliant with USB version 2.0 • Transfer speed: Full-speed (12 Mbps), low-speed (1.5 Mbps) • OTG (ON-The-Go) is supported. • Isochronous transfer is supported. • BC1.2 (Battery Charging Specification Revision 1.2) is supported. • Internal power supply for USB (allows operation without external power input to the VCC_USB pin when VCC = 4.0 to 5.5V)
	CAN module (RSCAN)	• 1 channel • Compliance with the ISO11898-1 specification (standard frame and extended frame) • 16 Message boxes

1.4 Pin Functions

Table 1.5 lists the pin functions.

Table 1.5 Pin Functions (1/4)

Classifications	Pin Name	I/O	Description
Power supply	VCC	Input	Power supply pin. Connect it to the system power supply.
	VCL	—	Connect this pin to the VSS pin via a 4.7 μF smoothing capacitor used to stabilize the internal power supply. Place the capacitor close to the pin.
	VSS	Input	Ground pin. Connect it to the system power supply (0 V).
	VBATT	Input	Backup power pin
Clock	XTAL	Output	Pins for connecting a crystal. An external clock can be input through the EXTAL pin.
	EXTAL	Input	
	BCLK	Output	Outputs the external bus clock for external devices.
	XCIN	Input	Input/output pins for the sub-clock oscillator. Connect a crystal between XCIN and XCOUT.
	XCOUT	Output	
	CLKOUT	Output	Clock output pin.
Operating mode control	MD	Input	Pin for setting the operating mode. The signal levels on this pin must not be changed during operation.
	UB	Input	Pin used for boot mode (USB interface).
	UPSEL	Input	Pin used for boot mode (USB interface).
System control	RES#	Input	Reset pin. This MCU enters the reset state when this signal goes low.
CAC	CACREF	Input	Input pin for the clock frequency accuracy measurement circuit.
On-chip emulator	FINED	I/O	FINE interface pin.
Address bus	A0 to A23	Output	Output pins for the address.
Data bus	D0 to D15	I/O	Input and output pins for the bidirectional data bus.
Multiplexed bus	A0/D0 to A15/D15	I/O	Address/data multiplexed bus
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress.
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in single-write strobe mode.
	WR0#, WR1#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, and D15 to D8) is valid in writing to the external bus interface space, in byte strobe mode.
	BC0#, BC1#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0 and D15 to D8) is valid in access to the external bus interface space, in single-write strobe mode.
	CS0# to CS3#	Output	Select signals for areas 0 to 3.
	WAIT#	Input	Input pin for wait request signals in access to the external space.
	ALE	Output	Address latch signal when address/data multiplexed bus is selected.
LVD	CMPA2	Input	Detection target voltage pin for voltage detection 2.
Interrupts	NMI	Input	Non-maskable interrupt request pin.
	IRQ0 to IRQ7	Input	Interrupt request pins.

Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (2/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	External Bus	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
E8		PA4	A4	MTIC5U/MTCLKA/TMRI0/ TIOCA1	TXD5/SMOSI5/SSDA5/ SSLA0/SSITXD0/IRTXD5			IRQ5 / CVREFB1
E9		PA5	A5	TIOCB1	RSPCKA			
E10		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB	RXD5/SMISO5/SSCL5/ SSIRXD0/IRRXD5			IRQ6 /CMPB1
F1	EXTAL	P36						
F2	VCC							
F3	UPSEL	P35						NMI
F4		P32		MTIOC0C/TMO3/TIOCC0/ RTCOUT/RTCIC2	TXD6/SMOSI6/SSDA6/ USB0_VBUSEN			IRQ2
F5		P12		TMCI1	SCL			IRQ2
F6		PB3	A11	MTIOC0A/MTIOC4A/TMO0/ POE3#/TIOCD3/TCLKD	SCK6	SDHI_WP		
F7		PB2	A10	TIOCC3/TCLKC	CTS6#/RTS6#/SS6#			
F8		PB0	A8	MTIC5W/TIOCA3	RXD6/SMISO6/SSCL6/ RSPCKA	SDHI_CMD		
F9		PA7	A7	TIOCB2	MISOA			
F10	VSS							
G1		P33		MTIOC0D/TMRI3/POE3#/ TIOCD0	RXD6/SMISO6/SSCL6		TS1	IRQ3
G2		P31		MTIOC4D/TMCI2/RTCIC1	CTS1#/RTS1#/SS1#/ SSISCK0			IRQ1
G3		P30		MTIOC4B/TMRI3/POE8#/ RTCIC0	RXD1/SMISO1/SSCL1/ AUDIO_MCLK			IRQ0/ CMPOB3
G4		P27	CS3#	MTIOC2B/TMCI3	SCK1/ SSIWS0		TS2	CVREFB3
G5	BCLK	P53					TS17	
G6		P52	RD#				TS18	
G7		PB5	A13	MTIOC2A/MTIOC1B/ TMRI1/POE1#/TIOCB4	SCK9/USB0_VBUS	SDHI_CD		
G8		PB4	A12	TIOCA4	CTS9#/RTS9#/SS9#			
G9		PB1	A9	MTIOC0C/MTIOC4C/ TMCI0/TIOCB3	TXD6/SMOSI6/SSDA6	SDHI_CLK		IRQ4/ CMPOB1
G10	VCC							
H1		P26	CS2#	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ SSIRXD0		TS3	CMPB3
H2		P25	CS1#	MTIOC4C/MTCLKB/ TIOCA4			TS4	ADTRG0#
H3		P16		MTIOC3C/MTIOC3D/ TMO2/TIOCB1/TCLKC/ RTCOUT	TXD1/SMOSI1/SSDA1/ MOSIA/SCL/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB			IRQ6/ ADTRG0#
H4		P15		MTIOC0B/MTCLKB/TMCI2/ TIOCB2/TCLKB	RXD1/SMISO1/SSCL1/ CRXD0		TS12	IRQ5/CMPB2
H5		P55	WAIT#	MTIOC4D/TMO3	CRXD0		TS15	
H6		P54	ALE	MTIOC4B/TMCI1	CTXD0		TS16	
H7	UB	PC7	A23/CS0#	MTIOC3A/MTCLKB/TMO2	TXD8/SMOSI8/SSDA8/ MISOA			CACREF
H8		PC6	A22/CS1#	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/ MOSIA		TS22	
H9		PB6	A14	MTIOC3D/TIOCA5	RXD9/SMISO9/SSCL9	SDHI_D1		
H10		PB7	A15	MTIOC3B/TIOCB5	TXD9/SMOSI9/SSDA9	SDHI_D2		
J1		P24	CS0#	MTIOC4A/MTCLKA/TMRI1/ TIOCB4	USB0_VBUSEN		TS5	
J2		P21		MTIOC1B/TMCI0/TIOCA3	RXD0/SMISO0/SSCL0/ USB0_EXICEN/SSIWS0		TS8	
J3		P17		MTIOC3A/MTIOC3B/TMO1/ POE8#/TIOCB0/TCLKD	SCK1/MISOA/SDA/ SSITXD0			IRQ7/ CMPOB2
J4		P13		MTIOC0B/TMO3/TIOCA5	SDA			IRQ3
J5	VSS_USB*1	PH0*1						CACREF*1

Table 1.7 List of Pins and Pin Functions (100-Pin LFQFP) (1/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	External Bus	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
1	VREFH							
2		P03						DA0
3	VREFL							
4		PJ3		MTIOC3C	CTS6#/RTS6#/SS6#			
5	VCL							
6	VBATT							
7	MD							FINED
8	XCIN							
9	XCOUT							
10	RES#							
11	XTAL	P37						
12	VSS							
13	EXTAL	P36						
14	VCC							
15	UPSEL	P35						NMI
16		P34		MTIOC0A/TMCI3/POE2#	SCK6		TS0	IRQ4
17		P33		MTIOC0D/TMRI3/POE3#/ TIOCD0	RXD6/SMISO6/SSCL6		TS1	IRQ3
18		P32		MTIOC0C/TMO3/TIOCC0/ RTCOUT/RTCIC2	TXD6/SMOSI6/SSDA6/ USB0_VBUSEN			IRQ2
19		P31		MTIOC4D/TMCI2/RTCIC1	CTS1#/RTS1#/SS1#/ SSISCK0			IRQ1
20		P30		MTIOC4B/TMRI3/POE8#/ RTCIC0	RXD1/SMISO1/SSCL1/ AUDIO_MCLK			IRQ0/ CMPOB3
21		P27	CS3#	MTIOC2B/TMCI3	SCK1/ SSIWS0		TS2	CVREFB3
22		P26	CS2#	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/ SSIRXD0		TS3	CMPB3
23		P25	CS1#	MTIOC4C/MTCLKB/ TIOCA4			TS4	ADTRG0#
24		P24	CS0#	MTIOC4A/MTCLKA/TMRI1/ TIOCB4	USB0_VBUSEN		TS5	
25		P23		MTIOC3D/MTCLKD/ TIOCD3	CTS0#/RTS0#/SS0#/ SSISCK0		TS6	
26		P22		MTIOC3B/MTCLKC/TMO0/ TIOCC3	SCK0/ USB0_OVRCURB/ AUDIO_MCLK		TS7	
27		P21		MTIOC1B/TMCI0/TIOCA3	RXD0/SMISO0/SSCL0/ USB0_EXICEN/SSIWS0		TS8	
28		P20		MTIOC1A/TMRI0/TIOCB3	TXD0/SMOSI0/SSDA0/ USB0_ID/SSIRXD0		TS9	
29		P17		MTIOC3A/MTIOC3B/TMO1/ POE8#/TIOCB0/TCLKD	SCK1/MISOA/SDA/ SSITXD0			IRQ7/ CMPOB2
30		P16		MTIOC3C/MTIOC3D/ TMO2/TIOCB1/TCLKC/ RTCOUT	TXD1/SMOSI1/SSDA1/ MOSIA/SCL/USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB			IRQ6/ ADTRG0#
31		P15		MTIOC0B/MTCLKB/TMCI2/ TIOCB2/TCLKB	RXD1/SMISO1/SSCL1/ CRXD0		TS12	IRQ5/CMPB2
32		P14		MTIOC3A/MTCLKA/TMRI2/ TIOCB5/TCLKA	CTS1#/RTS1#/SS1#/ CTXD0/USB0_OVRCURA		TS13	IRQ4/ CVREFB2
33		P13		MTIOC0B/TMO3/TIOCA5	SDA			IRQ3
34		P12		TMCI1	SCL			IRQ2
35	VCC_USB*1	PH3*1		TMCI0*1				
36		PH2*1		TMRI0*1	USB0_DM*1			IRQ1*1
37		PH1*1		TMO0*1	USB0_DP*1			IRQ0*1
38	VSS_USB*1	PH0*1						CACREF*1
39		P55	WAIT#	MTIOC4D/TMO3	CRXD0		TS15	
40		P54	ALE	MTIOC4B/TMCI1	CTXD0		TS16	
41	BCLK	P53					TS17	

Table 1.7 List of Pins and Pin Functions (100-Pin LFQFP) (2/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	External Bus	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
42		P52	RD#				TS18	
43		P51	WR1#/BC1#/ WAIT#				TS19	
44		P50	WR0#/WR#				TS20	
45	UB	PC7	A23/CS0#	MTIOC3A/MTCLKB/TMO2	TXD8/SMOSI8/SSDA8/ MISOA			CACREF
46		PC6	A22/CS1#	MTIOC3C/MTCLKA/TMCI2	RXD8/SMISO8/SSCL8/ MOSIA		TS22	
47		PC5	A21/CS2#/ WAIT#	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA		TS23	
48		PC4	A20/CS3#	MTIOC3D/MTCLKC/TMCI1/ POE0#	SCK5/CTS8#/RTS8#/ SS8#/SSLA0	SDHI_D1	TSCAP	
49		PC3	A19	MTIOC4D/TCLKB	TXD5/SMOSI5/SSDA5/ IRTXD5	SDHI_D0	TS27	
50		PC2	A18	MTIOC4B/TCLKA	RXD5/SMISO5/SSCL5/ SSLA3/ IRRXD5	SDHI_D3	TS30	
51		PC1	A17	MTIOC3A/TCLKD	SCK5/SSLA2		TS33	
52		PC0	A16	MTIOC3C/TCLKC	CTS5#/RTS5#/SS5#/ SSLA1		TS35	
53		PB7	A15	MTIOC3B/TIOCB5	TXD9/SMOSI9/SSDA9	SDHI_D2		
54		PB6	A14	MTIOC3D/TIOCA5	RXD9/SMISO9/SSCL9	SDHI_D1		
55		PB5	A13	MTIOC2A/MTIOC1B/ TMRI1/POE1#/TIOCB4	SCK9/USB0_VBUS	SDHI_CD		
56		PB4	A12	TIOCA4	CTS9#/RTS9#/SS9#			
57		PB3	A11	MTIOC0A/MTIOC4A/TMO0/ POE3#/TIOCD3/TCLKD	SCK6	SDHI_WP		
58		PB2	A10	TIOCC3/TCLKC	CTS6#/RTS6#/SS6#			
59		PB1	A9	MTIOC0C/MTIOC4C/ TMCI0/TIOCB3	TXD6/SMOSI6/SSDA6	SDHI_CLK		IRQ4/ CMPOB1
60	VCC							
61		PB0	A8	MTIC5W/TIOCA3	RXD6/SMISO6/SSCL6/ RSPCKA	SDHI_CMD		
62	VSS							
63		PA7	A7	TIOCB2	MISOA			
64		PA6	A6	MTIC5V/MTCLKB/TMCI3/ POE2#/TIOCA2	CTS5#/RTS5#/SS5#/ MOSIA/SSIWS0			
65		PA5	A5	TIOCB1	RSPCKA			
66		PA4	A4	MTIC5U/MTCLKA/TMRI0/ TIOCA1	TXD5/SMOSI5/SSDA5/ SSLA0/SSITXD0/IRTXD5			IRQ5 / CVREFB1
67		PA3	A3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB	RXD5/SMISO5/SSCL5/ SSIRXD0/IRRXD5			IRQ6 /CMPB1
68		PA2	A2		RXD5/SMISO5/SSCL5/ SSLA3/IRRXD5			
69		PA1	A1	MTIOC0B/MTCLKC/ TIOCB0	SCK5/SSLA2/SSISCK0			
70		PA0	A0/BC0#	MTIOC4A/TIOCA0	SSLA1			CACREF
71		PE7	D15[A15/D15]					IRQ7/AN023
72		PE6	D14[A14/D14]					IRQ6/AN022
73		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B				IRQ5/AN021/ CMPOB0
74		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A				AN020/ CMPA2/ CLKOUT
75		PE3	D11[A11/D11]	MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/ AUDIO_MCLK			AN019/ CLKOUT
76		PE2	D10[A10/D10]	MTIOC4A	RXD12/RXDX12/ SMISO12/SSCL12			IRQ7/AN018/ CVREFB0
77		PE1	D9[A9/D9]	MTIOC4C	TXD12/TXDX12/SIOX12/ SMOSI12/SSDA12			AN017/ CMPB0
78		PE0	D8[A8/D8]		SCK12			AN016

Table 4.1 List of I/O Registers (Address Order) (6/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
0008 8158h	TPU4	Timer General Register A	TGRA	16	16	2 or 3 PCLKB	2 ICLK
0008 815Ah	TPU4	Timer General Register B	TGRB	16	16	2 or 3 PCLKB	2 ICLK
0008 8160h	TPU5	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8161h	TPU5	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB	2 ICLK
0008 8162h	TPU5	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKB	2 ICLK
0008 8164h	TPU5	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB	2 ICLK
0008 8165h	TPU5	Timer Status Register	TSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8166h	TPU5	Timer Counter	TCNT	16	16	2 or 3 PCLKB	2 ICLK
0008 8168h	TPU5	Timer General Register A	TGRA	16	16	2 or 3 PCLKB	2 ICLK
0008 816Ah	TPU5	Timer General Register B	TGRB	16	16	2 or 3 PCLKB	2 ICLK
0008 8200h	TMR0	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8201h	TMR1	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8202h	TMR0	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8203h	TMR1	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8204h	TMR0	Time Constant Register A	TCORA	8	8	2 or 3 PCLKB	2 ICLK
0008 8205h	TMR1	Time Constant Register A	TCORA	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8206h	TMR0	Time Constant Register B	TCORB	8	8	2 or 3 PCLKB	2 ICLK
0008 8207h	TMR1	Time Constant Register B	TCORB	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8208h	TMR0	Timer Counter	TCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 8209h	TMR1	Timer Counter	TCNT	8	8*1	2 or 3 PCLKB	2 ICLK
0008 820Ah	TMR0	Timer Counter Control Register	TCCR	8	8	2 or 3 PCLKB	2 ICLK
0008 820Bh	TMR1	Timer Counter Control Register	TCCR	8	8*1	2 or 3 PCLKB	2 ICLK
0008 820Ch	TMR0	Timer Count Start Register	TCSTR	8	8	2 or 3 PCLKB	2 ICLK
0008 8210h	TMR2	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8211h	TMR3	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8212h	TMR2	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8213h	TMR3	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8214h	TMR2	Time Constant Register A	TCORA	8	8	2 or 3 PCLKB	2 ICLK
0008 8215h	TMR3	Time Constant Register A	TCORA	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8216h	TMR2	Time Constant Register B	TCORB	8	8	2 or 3 PCLKB	2 ICLK
0008 8217h	TMR3	Time Constant Register B	TCORB	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8218h	TMR2	Timer Counter	TCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 8219h	TMR3	Timer Counter	TCNT	8	8*1	2 or 3 PCLKB	2 ICLK
0008 821Ah	TMR2	Timer Counter Control Register	TCCR	8	8	2 or 3 PCLKB	2 ICLK
0008 821Bh	TMR3	Timer Counter Control Register	TCCR	8	8*1	2 or 3 PCLKB	2 ICLK
0008 821Ch	TMR2	Timer Count Start Register	TCSTR	8	8	2 or 3 PCLKB	2 ICLK
0008 8280h	CRC	CRC Control Register	CRCCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8281h	CRC	CRC Data Input Register	CRCDIR	8	8	2 or 3 PCLKB	2 ICLK
0008 8282h	CRC	CRC Data Output Register	CRCDOR	16	16	2 or 3 PCLKB	2 ICLK
0008 8300h	RIIC0	I^2C-Bus Control Register 1	ICCR1	8	8	2 or 3 PCLKB	2 ICLK
0008 8301h	RIIC0	I^2C-Bus Control Register 2	ICCR2	8	8	2 or 3 PCLKB	2 ICLK
0008 8302h	RIIC0	I^2C-Bus Mode Register 1	ICMR1	8	8	2 or 3 PCLKB	2 ICLK
0008 8303h	RIIC0	I^2C-Bus Mode Register 2	ICMR2	8	8	2 or 3 PCLKB	2 ICLK
0008 8304h	RIIC0	I^2C-Bus Mode Register 3	ICMR3	8	8	2 or 3 PCLKB	2 ICLK
0008 8305h	RIIC0	I^2C-Bus Function Enable Register	ICFER	8	8	2 or 3 PCLKB	2 ICLK
0008 8306h	RIIC0	I^2C-Bus Status Enable Register	ICSER	8	8	2 or 3 PCLKB	2 ICLK
0008 8307h	RIIC0	I^2C-Bus Interrupt Enable Register	ICIER	8	8	2 or 3 PCLKB	2 ICLK
0008 8308h	RIIC0	I^2C-Bus Status Register 1	ICSR1	8	8	2 or 3 PCLKB	2 ICLK
0008 8309h	RIIC0	I^2C-Bus Status Register 2	ICSR2	8	8	2 or 3 PCLKB	2 ICLK
0008 830Ah	RIIC0	Slave Address Register L0	SARL0	8	8	2 or 3 PCLKB	2 ICLK
0008 830Bh	RIIC0	Slave Address Register U0	SARU0	8	8	2 or 3 PCLKB	2 ICLK
0008 830Ch	RIIC0	Slave Address Register L1	SARL1	8	8	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (10/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
0008 A012h	SCI0	Modulation Duty Register	MDDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2 or 3 PCLKB	2 ICLK
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2 or 3 PCLKB	2 ICLK
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A024h	SCI1	Serial Status Register	SSR	8	8	2 or 3 PCLKB	2 ICLK
0008 A025h	SCI1	Receive Data Register	RDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A026h	SCI1	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A027h	SCI1	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A028h	SCI1	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB	2 ICLK
0008 A029h	SCI1	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Ah	SCI1	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Bh	SCI1	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Ch	SCI1	I^2C Status Register	SISR	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Dh	SCI1	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Eh	SCI1	Transmit Data Register HL	TDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A02Eh	SCI1	Transmit Data Register H	TDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A02Fh	SCI1	Transmit Data Register L	TDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A030h	SCI1	Receive Data Register HL	RDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A030h	SCI1	Receive Data Register H	RDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A031h	SCI1	Receive Data Register L	RDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A032h	SCI1	Modulation Duty Register	MDDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A0h	SCI5	Serial Mode Register	SMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A1h	SCI5	Bit Rate Register	BRR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A2h	SCI5	Serial Control Register	SCR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A3h	SCI5	Transmit Data Register	TDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A4h	SCI5	Serial Status Register	SSR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A5h	SCI5	Receive Data Register	RDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A6h	SCI5	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A7h	SCI5	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A8h	SCI5	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0A9h	SCI5	I^2C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB	2 ICLK
0008 A0AAh	SCI5	I^2C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB	2 ICLK
0008 A0ABh	SCI5	I^2C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB	2 ICLK
0008 A0ACh	SCI5	I^2C Status Register	SISR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0ADh	SCI5	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0AEh	SCI5	Transmit Data Register HL	TDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A0AEh	SCI5	Transmit Data Register H	TDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A0AFh	SCI5	Transmit Data Register L	TDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A0B0h	SCI5	Receive Data Register HL	RDRHL	16	16	4 or 5 PCLKB	2 ICLK
0008 A0B0h	SCI5	Receive Data Register H	RDRH	8	8	2 or 3 PCLKB	2 ICLK
0008 A0B1h	SCI5	Receive Data Register L	RDRL	8	8	2 or 3 PCLKB	2 ICLK
0008 A0B2h	SCI5	Modulation Duty Register	MDDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C0h	SCI6	Serial Mode Register	SMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C1h	SCI6	Bit Rate Register	BRR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C2h	SCI6	Serial Control Register	SCR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C3h	SCI6	Transmit Data Register	TDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C4h	SCI6	Serial Status Register	SSR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C5h	SCI6	Receive Data Register	RDR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C6h	SCI6	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C7h	SCI6	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB	2 ICLK
0008 A0C8h	SCI6	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (32/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK <PCLK
000D 0A34h	MTU	Timer Dead Time Enable Register	TDER	8	8	2 or 3 PCLKA	2 ICLK
000D 0A36h	MTU	Timer Output Level Buffer Register	TOLBR	8	8	2 or 3 PCLKA	2 ICLK
000D 0A38h	MTU3	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKA	2 ICLK
000D 0A39h	MTU4	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKA	2 ICLK
000D 0A40h	MTU4	Timer A/D Converter Start Request Control Register	TADCR	16	16	2 or 3 PCLKA	2 ICLK
000D 0A44h	MTU4	Timer A/D Converter Start Request Cycle Set Register A	TADCORA	16	16	2 or 3 PCLKA	2 ICLK
000D 0A46h	MTU4	Timer A/D Converter Start Request Cycle Set Register B	TADCORB	16	16	2 or 3 PCLKA	2 ICLK
000D 0A48h	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register A	TADCOBRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0A4Ah	MTU4	Timer A/D Converter Start Request Cycle Set Buffer Register B	TADCOBRB	16	16	2 or 3 PCLKA	2 ICLK
000D 0A60h	MTU	Timer Waveform Control Register	TWCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A80h	MTU	Timer Start Register	TSTR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A81h	MTU	Timer Synchronous Register	TSYR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A84h	MTU	Timer Read/Write Enable Register	TRWER	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A90h	MTU0	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A91h	MTU1	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A92h	MTU2	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A93h	MTU3	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A94h	MTU4	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0A95h	MTU5	Noise Filter Control Register	NFCR	8	8, 16	2 or 3 PCLKA	2 ICLK
000D 0B00h	MTU0	Timer Control Register	TCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B01h	MTU0	Timer Mode Register	TMDR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B02h	MTU0	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKA	2 ICLK
000D 0B03h	MTU0	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKA	2 ICLK
000D 0B04h	MTU0	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKA	2 ICLK
000D 0B05h	MTU0	Timer Status Register	TSR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B06h	MTU0	Timer Counter	TCNT	16	16	2 or 3 PCLKA	2 ICLK
000D 0B08h	MTU0	Timer General Register A	TGRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0B0Ah	MTU0	Timer General Register B	TGRB	16	16	2 or 3 PCLKA	2 ICLK
000D 0B0Ch	MTU0	Timer General Register C	TGRC	16	16	2 or 3 PCLKA	2 ICLK
000D 0B0Eh	MTU0	Timer General Register D	TGRD	16	16	2 or 3 PCLKA	2 ICLK
000D 0B20h	MTU0	Timer General Register E	TGRE	16	16	2 or 3 PCLKA	2 ICLK
000D 0B22h	MTU0	Timer General Register F	TGRF	16	16	2 or 3 PCLKA	2 ICLK
000D 0B24h	MTU0	Timer Interrupt Enable Register 2	TIER2	8	8	2 or 3 PCLKA	2 ICLK
000D 0B26h	MTU0	Timer Buffer Operation Transfer Mode Register	TBTM	8	8	2 or 3 PCLKA	2 ICLK
000D 0B80h	MTU1	Timer Control Register	TCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B81h	MTU1	Timer Mode Register	TMDR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B82h	MTU1	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B84h	MTU1	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKA	2 ICLK
000D 0B85h	MTU1	Timer Status Register	TSR	8	8	2 or 3 PCLKA	2 ICLK
000D 0B86h	MTU1	Timer Counter	TCNT	16	16	2 or 3 PCLKA	2 ICLK
000D 0B88h	MTU1	Timer General Register A	TGRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0B8Ah	MTU1	Timer General Register B	TGRB	16	16	2 or 3 PCLKA	2 ICLK
000D 0B90h	MTU1	Timer Input Capture Control Register	TICCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C00h	MTU2	Timer Control Register	TCR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C01h	MTU2	Timer Mode Register	TMDR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C02h	MTU2	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C04h	MTU2	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKA	2 ICLK
000D 0C05h	MTU2	Timer Status Register	TSR	8	8	2 or 3 PCLKA	2 ICLK
000D 0C06h	MTU2	Timer Counter	TCNT	16	16	2 or 3 PCLKA	2 ICLK
000D 0C08h	MTU2	Timer General Register A	TGRA	16	16	2 or 3 PCLKA	2 ICLK
000D 0C0Ah	MTU2	Timer General Register B	TGRB	16	16	2 or 3 PCLKA	2 ICLK

5. Electrical Characteristics

5.1 Absolute Maximum Ratings

Table 5.1 Absolute Maximum Ratings

Conditions: VSS = AVSS0 = VREFL0 = VREFL= VSS_USB = 0 V

Item		Symbol	Value	Unit
Power supply voltage		VCC, VCC_USB	–0.3 to +6.5	V
VBATT power supply voltage		Vbatt	–0.3 to +6.5	V
Input voltage	Ports for 5 V tolerant*1	V_{in}	–0.3 to +6.5	V
	P03, P05, P07, P40 to P47		–0.3 to AVCC0 +0.3	
	Ports other than above		–0.3 to VCC +0.3	
Reference power supply voltage		VREFH0	–0.3 to AVCC0 +0.3	V
		VREFH		
Analog power supply voltage		AVCC0	–0.3 to +6.5	V
Analog input voltage	When AN000 to AN007 are used	V_{AN}	–0.3 to AVCC0 +0.3	V
	When AN016 to AN031 are used		–0.3 to VCC +0.3	
Operating temperature*2		T_{opr}	–40 to +85 –40 to +105	°C
Storage temperature		T_{stg}	–55 to +125	°C

Caution: Permanent damage to the MCU may be caused if absolute maximum ratings are exceeded.

To preclude any malfunctions due to noise interference, insert capacitors with high frequency characteristics between the VCC and VSS pins, between the AVCC0 and AVSS0 pins, between the VCC_USB and VSS_USB pins, between the VREFH0 and VREFL0 pins, and between the VREFH and VREFL pins. Place capacitors of about 0.1 µF as close as possible to every power supply pin and use the shortest and heaviest possible traces.

Connect the VCL pin to a VSS pin via a 4.7 µF capacitor. The capacitor must be placed close to the pin. For details, refer to section 5.15.1, Connecting VCL Capacitor and Bypass Capacitors.

Do not input signals or an I/O pull-up power supply to ports other than 5-V tolerant ports while the device is not powered.

The current injection that results from input of such a signal or I/O pull-up may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Even if –0.3 to +6.5 V is input to 5-V tolerant ports, it will not cause problems such as damage to the MCU.

Note 1. Ports 12, 13, 16, 17, 30, 31, 32, and B5 are 5 V tolerant.

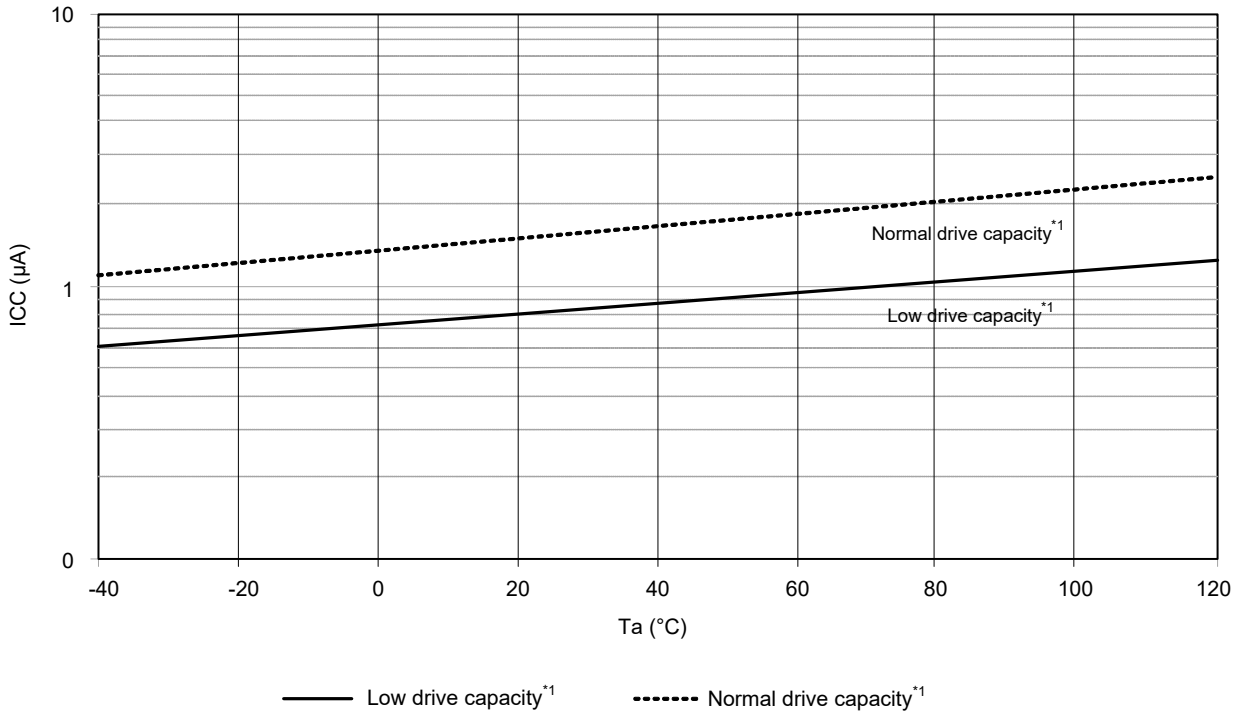
Note 2. The upper limit of operating temperature is 85°C or 105°C, depending on the product. For details, refer to section 1.2, List of Products.

5.2 DC Characteristics

Table 5.3 DC Characteristics (1)

Conditions: 2.7 V ≤ VCC = VCC_USB ≤ 5.5 V, 2.7 V ≤ AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	RIIC input pin (except for SMBus, 5 V tolerant)		V_{IH}	VCC × 0.7	—	5.8	V	
	Ports 12, 13, 16, 17, port B5 (5 V tolerant)			VCC × 0.8	—	5.8		
	Ports 14 to 15, ports 20 to 27, ports 33 to 37, ports 50 to 55, ports A0 to A7, ports B0 to B4, B6, B7 ports C0 to C7, ports D0 to D7, ports E0 to E7, port J3, Ports 30 to 32 (when time capture event input is not selected), RES#			VCC × 0.8	—	VCC + 0.3		
	Ports 03, 05, 07, ports 40 to 47			AVCC0 × 0.8	—	AVCC0 + 0.3		
	Ports 30 to 32 (when time capture event input is selected)	When VCC is supplied		VCC × 0.8	—	VCC + 0.3		
		When VBATT is supplied		VBATT × 0.8	—	VBATT + 0.3		
	Ports 03, 05, 07, ports 40 to 47		V_{IL}	–0.3	—	AVCC0 × 0.2		
	RIIC input pin (except for SMBus)			–0.3	—	VCC × 0.3		
	Other than RIIC input pin or ports 30 to 32			–0.3	—	VCC × 0.2		
	Ports 30 to 32 (when time capture event input is selected)	When VCC is supplied		–0.3	—	VCC × 0.3		
		When VBATT is supplied		–0.3	—	VBATT × 0.3		
	Ports 03, 05, 07, ports 40 to 47		ΔV_T	AVCC0 × 0.1	—	—		
	RIIC input pin (except for SMBus)			VCC × 0.05	—	—		
	Ports 12, 13, 16, 17, Port B5			VCC × 0.05	—	—		
	Other than RIIC input pin			VCC × 0.1	—	—		
Input level voltage (except for Schmitt trigger input pins)	MD		V_{IH}	VCC × 0.9	—	VCC + 0.3	V	
	EXTAL (external clock input)			VCC × 0.8	—	VCC + 0.3		
	RIIC input pin (SMBus)			2.1	—	VCC + 0.3		
	MD		V_{IL}	–0.3	—	VCC × 0.1		
	EXTAL (external clock input)			–0.3	—	VCC × 0.2		
	RIIC input pin (SMBus)			–0.3	—	0.8		



Note 1. Indicates the average of the typical samples through actual measurement during product evaluation.

Figure 5.6 Temperature Dependency of RTC Operation with VCC Off (Reference Data)

Table 5.10 DC Characteristics (8)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Permissible total power consumption*1	Pd	—	—	350	mW	D-version product
Permissible total power consumption*1	Pd	—	—	130	mW	G-version product

Note: Please contact a Renesas Electronics sales office for information on the derating of the G-version product. Derating is the systematic reduction of load to improve reliability.

Note 1. Total power dissipated by the entire chip (including output currents)

5.2.1 Normal I/O Pin Output Characteristics (1)

Figure 5.8 to Figure 5.12 show the characteristics when normal output is selected by the drive capacity control register.

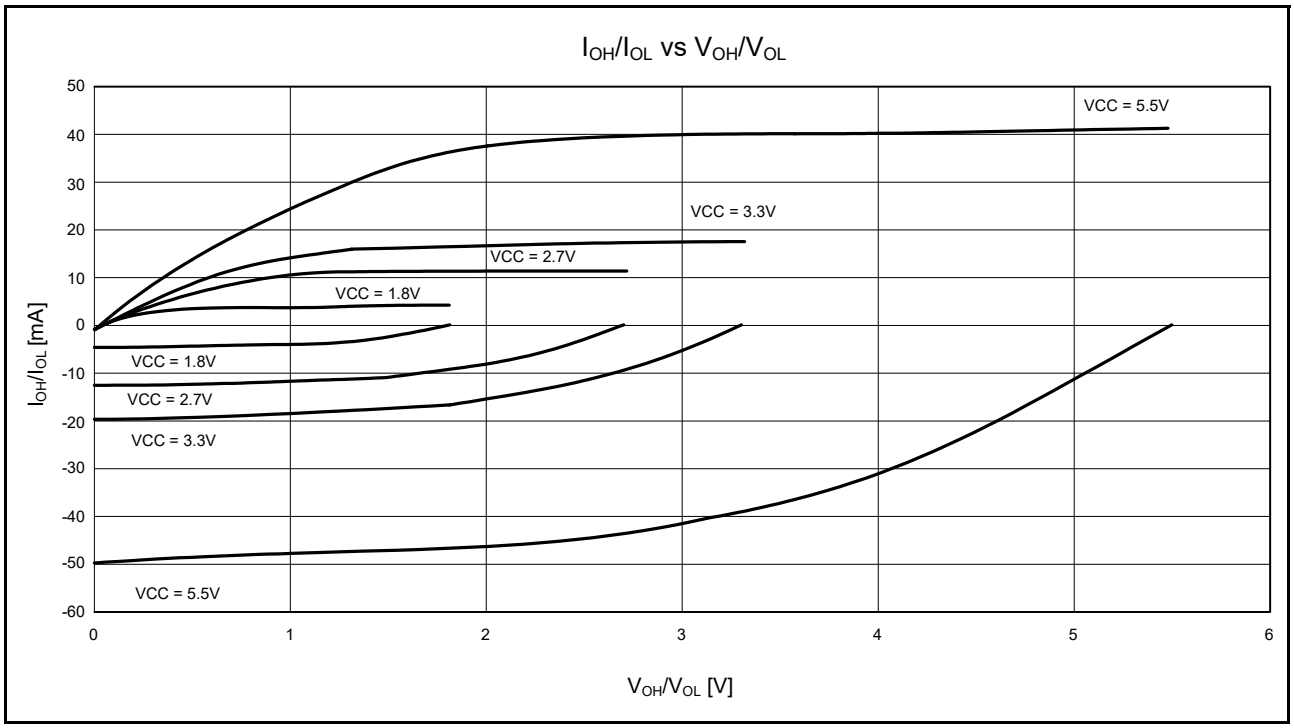


Figure 5.8 V_{OH}/V_{OL} and I_{OH}/I_{OL} Voltage Characteristics at T_a = 25°C When Normal Output is Selected (Reference Data)

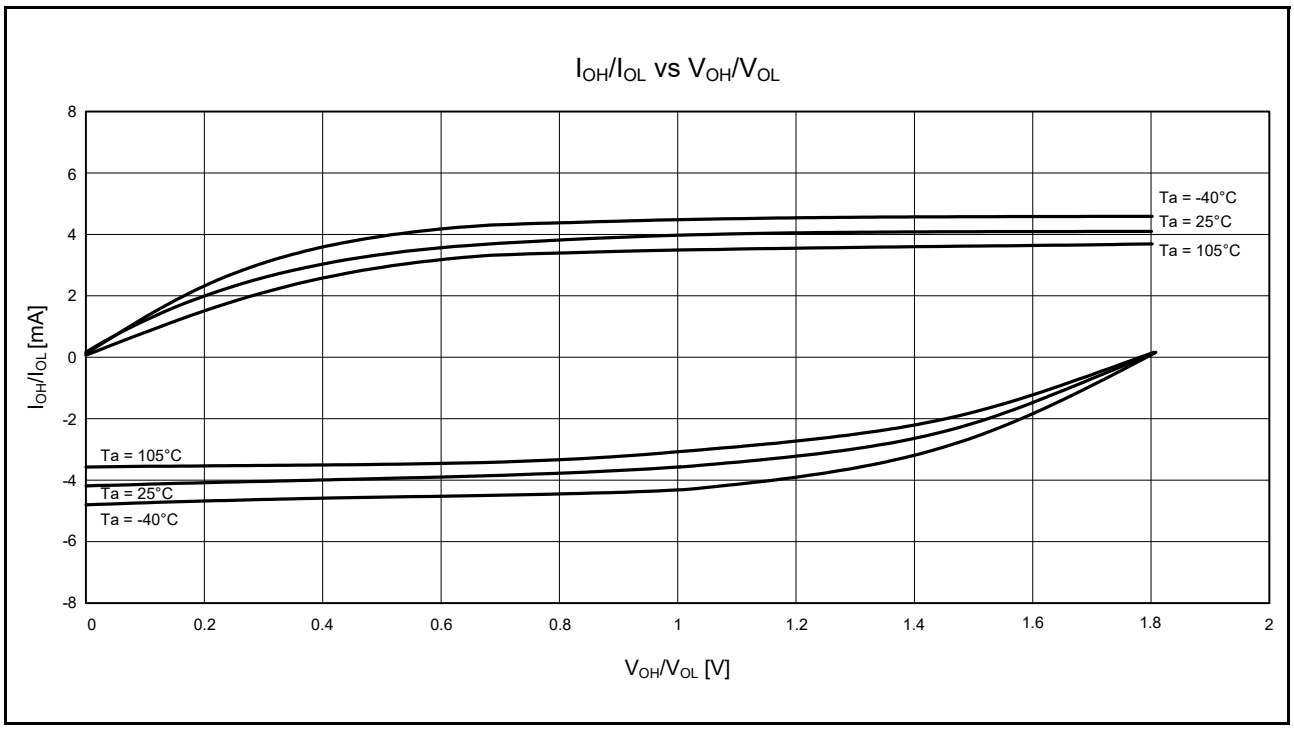


Figure 5.9 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 1.8 V When Normal Output is Selected (Reference Data)

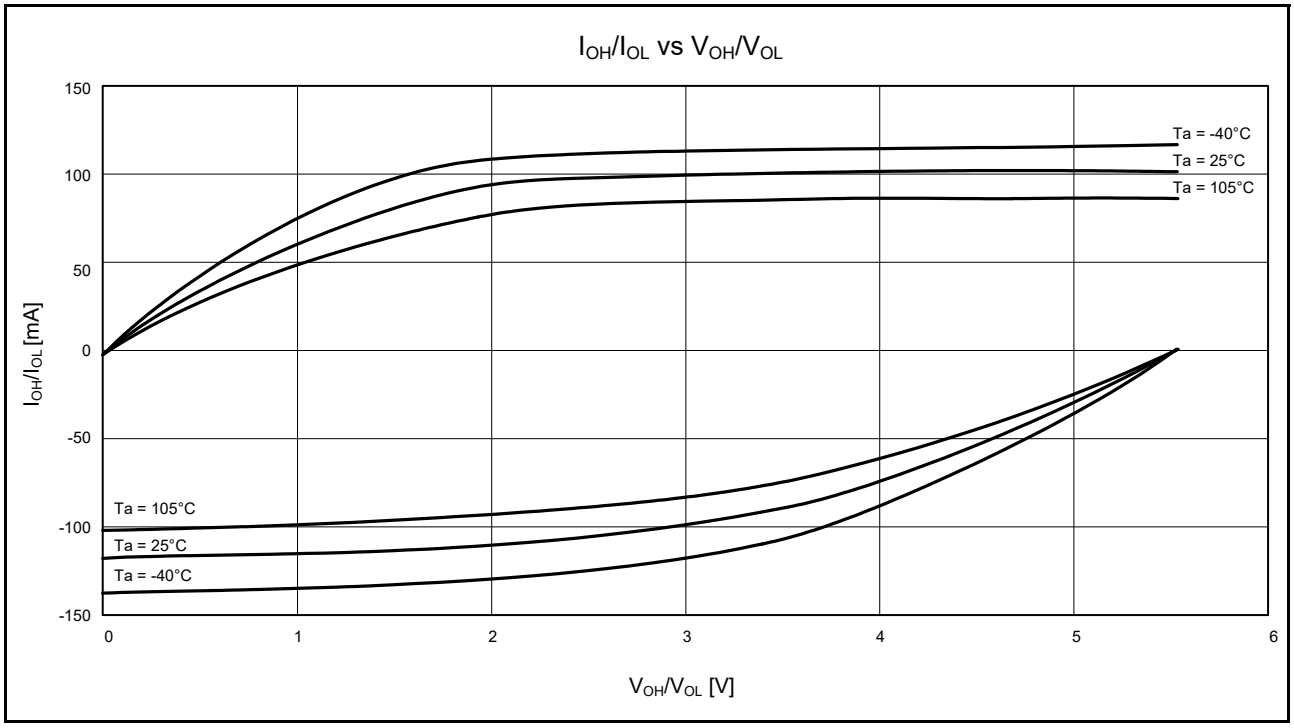


Figure 5.17 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at VCC = 5.5 V When High-Drive Output is Selected (Reference Data)

Table 5.36 Bus Timing (Multiplex bus) (1)

Conditions: 2.7 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V,
fBCLK ≤ 32 MHz (BCLK pin output frequency ≤ 16 MHz), T_a = –40 to +105°C, V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5,
I_{OH} = –1.0 mA, I_{OL} = 1.0 mA, C_L = 30 pF, when normal output is selected by the drive capacity control register

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	55	ns	Figure 5.43, Figure 5.44
Byte control delay time	t_{BCD}	—	55	ns	
CS# delay time	t_{CSD}	—	55	ns	
RD# delay time	t_{RSD}	—	55	ns	
ALE delay time	t_{ALED}	—	55	ns	
Read data setup time	t_{RDS}	40	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	55	ns	
Write data delay time	t_{WDD}	—	55	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	40	—	ns	Figure 5.42
WAIT# hold time	t_{WTH}	0	—	ns	

Table 5.37 Bus Timing (Multiplex bus) (2)

Conditions: 1.8 V ≤ VCC = VCC_USB = AVCC0 < 5.5 V, VSS = AVSS0 = VSS_USB = 0 V,
fBCLK ≤ 16 MHz (BCLK pin output frequency ≤ 8 MHz), T_a = –40 to +105°C, V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5,
I_{OH} = –1.0 mA, I_{OL} = 1.0 mA, C_L = 30 pF, when normal output is selected by the drive capacity control register

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	90	ns	Figure 5.43, Figure 5.44
Byte control delay time	t_{BCD}	—	90	ns	
CS# delay time	t_{CSD}	—	90	ns	
RD# delay time	t_{RSD}	—	90	ns	
ALE delay time	t_{ALED}	—	90	ns	
Read data setup time	t_{RDS}	60	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	90	ns	
Write data delay time	t_{WDD}	—	90	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	60	—	ns	Figure 5.42
WAIT# hold time	t_{WTH}	0	—	ns	

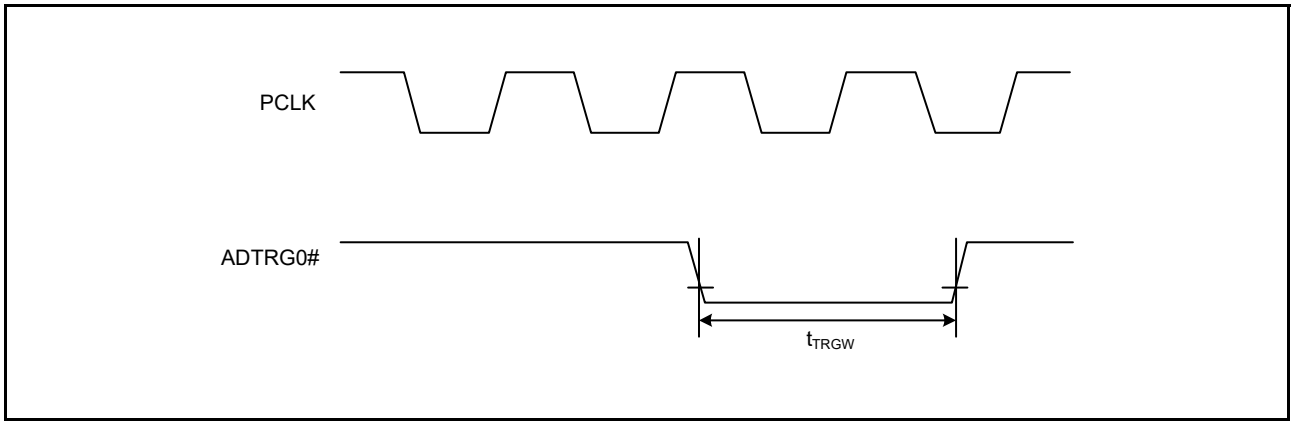


Figure 5.52 A/D Converter External Trigger Input Timing

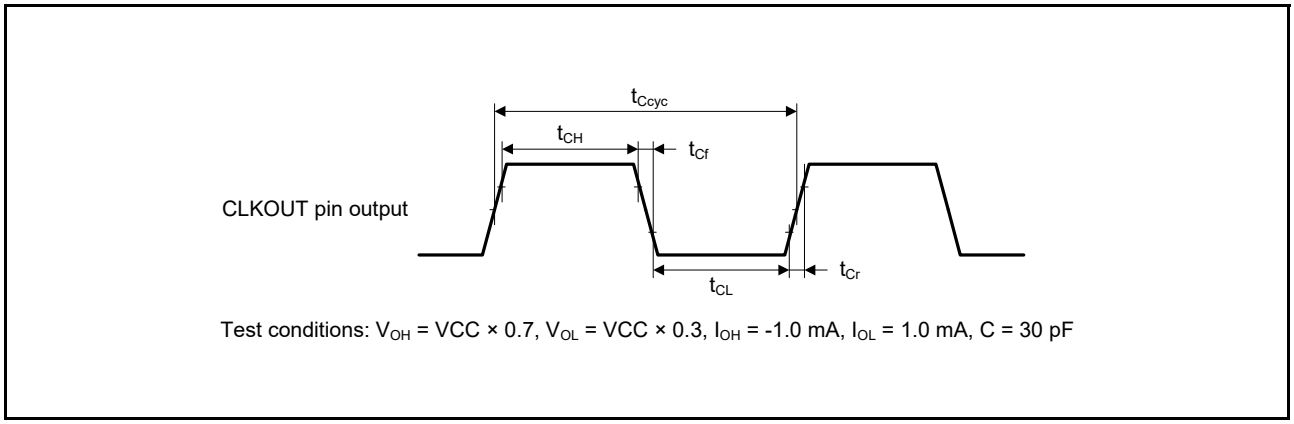


Figure 5.53 CLKOUT Output Timing

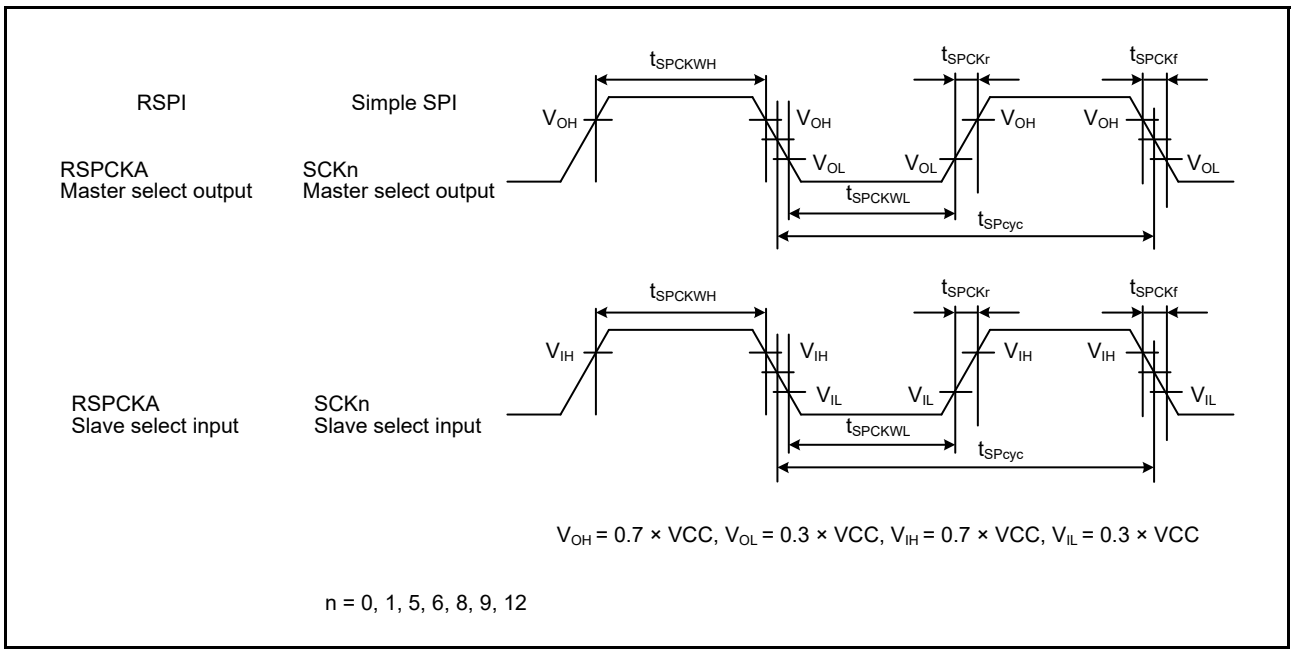


Figure 5.54 RSPI Clock Timing and Simple SPI Clock Timing

5.4 USB Characteristics

Table 5.45 USB Characteristics (USB0_DP and USB0_DM Pin Characteristics)

Conditions: 3.0 V ≤ VCC = VCC_USB = AVCC < 3.6 V (when a regulator is not in use) or 4.0 V ≤ VCC = AVCC0 < 5.5 V (when a regulator is in use), VSS = AVSS0 = VSS_USB = 0 V, T_a = –40 to +105°C

Item			Symbol	Min.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage		V_{IH}	2.0	—	V	
	Input low level voltage		V_{IL}	—	0.8	V	
	Differential input sensitivity		V_{DI}	0.2	—	V	| USB0_DP – USB0_DM |
	Differential common mode range		V_{CM}	0.8	2.5	V	
Output characteristics	Output high level voltage		V_{OH}	2.8	VCC_USB	V	I_{OH} = –200 µA
	Output low level voltage		V_{OL}	0.0	0.3	V	I_{OL} = 2 mA
	Cross-over voltage		V_{CRS}	1.3	2.0	V	Figure 5.65, Figure 5.66
	Rise time	FS	t_r	4	20	ns	
		LS		75	300		
	Fall time	FS	t_f	4	20	ns	
		LS		75	300		
	Rise/fall time ratio	FS	t_r/t_f	90	111.11	%	t_r/t_f
		LS		80	125		
	Output resistance		Z_{DRV}	28	44	Ω	(Adjusting the resistance by external elements is not necessary.)
VBUS characteristics	VBUS input voltage		V_{IH}	VCC × 0.8	—	V	
			V_{IL}	—	VCC × 0.2	V	
Pull-up, pull-down	Pull-down resistor		R_{PD}	14.25	24.80	kΩ	
	Pull-up resistor		R_{PUI}	0.9	1.575	kΩ	During idle state
			R_{PUA}	1.425	3.09	kΩ	During reception
Battery Charging Specification Ver 1.2	D+ sink current		I_{DP_SINK}	25	175	µA	
	D- sink current		I_{DM_SINK}	25	175	µA	
	DCD source current		I_{DP_SRC}	7	13	µA	
	Data detection voltage		V_{DAT_REF}	0.25	0.4	V	
	D+ source current		V_{DP_SRC}	0.5	0.7	V	Output current = 250 µA
	D- source current		V_{DM_SRC}	0.5	0.7	V	Output current = 250 µA

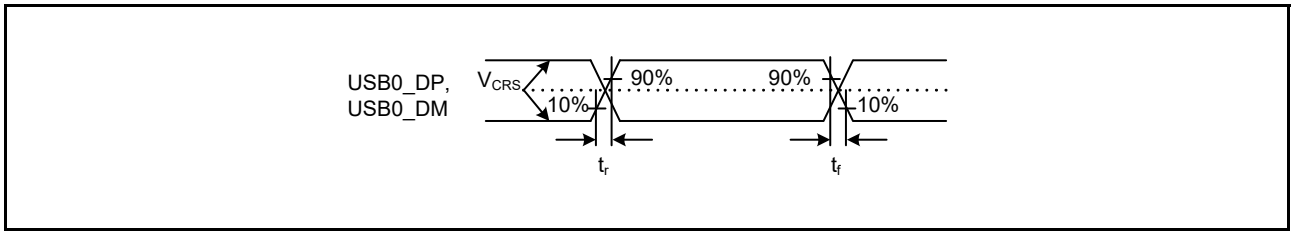


Figure 5.65 USB0_DP and USB0_DM Output Timing

Table 5.49 A/D Conversion Characteristics (4)

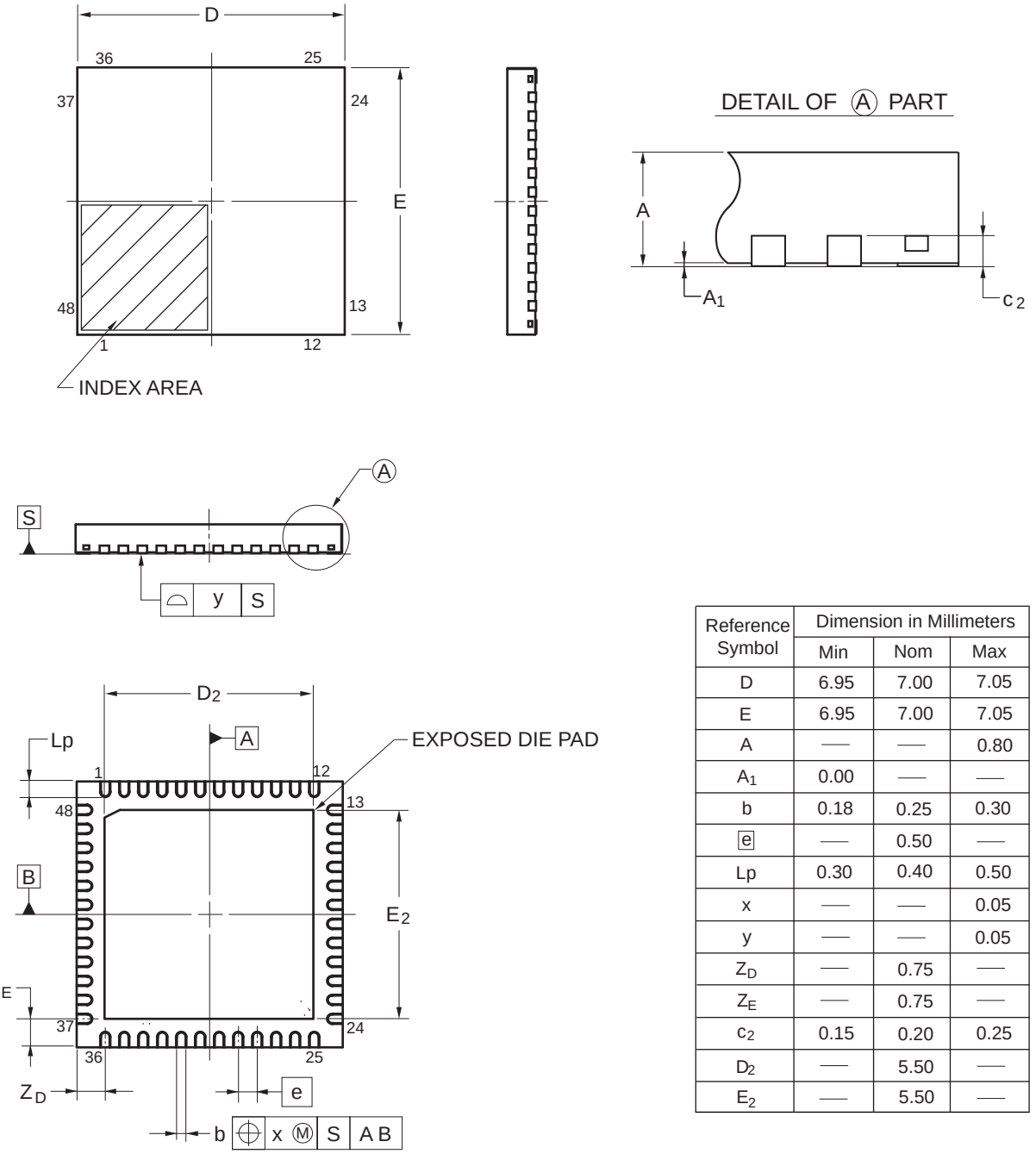
Conditions: 2.4V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5V, 2.4V ≤ VREFH0 ≤ AVCC0, VSS = AVSS0 = VSS_USB = 0V, reference voltage = VREFH0 selected, Ta = –40 to +105°C

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		1	—	16	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 16 MHz)	Permissible signal source impedance (Max.) = 2.2 kΩ	3.38	—	—	µs	High-precision channel The ADCSR.ADHSC bit is 1 The ADSSTRn register is 0Dh
		5.06	—	—		Normal-precision channel The ADCSR.ADHSC bit is 1 The ADSSTRn register is 28h
Analog input capacitance	Cs	—	—	15	pF	Pin capacitance included Figure 5.68
Analog input resistance	Rs	—	—	2.5	kΩ	Figure 5.68
Offset error		—	±0.5	±4.5	LSB	
Full-scale error		—	±0.75	±4.5	LSB	
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±1.25	±5.0	LSB	High-precision channel
				±8.0	LSB	Other than above
DNL differential non-linearity error		—	±1.0	—	LSB	
INL integral non-linearity error		—	±1.0	±3.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential non-linearity error, and INL integral non-linearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

JEITA Package code	RENESAS code	Previous code	MASS(TYP.)[g]
P-HWQFN48-7x7-0.50	PWQN0048KB-A	48PJN-A P48K8-50-5B4-7	0.13



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	6.95	7.00	7.05
E	6.95	7.00	7.05
A	—	—	0.80
A_1	0.00	—	—
b	0.18	0.25	0.30
e	—	0.50	—
Lp	0.30	0.40	0.50
x	—	—	0.05
y	—	—	0.05
Z_D	—	0.75	—
Z_E	—	0.75	—
c_2	0.15	0.20	0.25
D_2	—	5.50	—
E_2	—	5.50	—

Figure F 48 -Pin HWQFN (PWQN0048KB-A)

Rev.	Date	Description		Classification
		Page	Summary	
1.20	Sep 28, 2018	95	Figure 5.12 VOH/VOL and IOH/IOL Temperature Characteristics at VCC = 5.5 V When Normal Output is Selected (Reference Data), changed	TN-RX*-A201A/E
		124	Table 5.44 Timing of On-Chip Peripheral Modules (7), added	TN-RX*-A197A/E
		131	Figure 5.64 SD Host Interface Input/Output Signal Timing, added	TN-RX*-A197A/E
		132	Table 5.45 USB Characteristics (USB0_DP and USB0_DM Pin Characteristics) conditions, changed	

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NOTES FOR CMOS DEVICES

(1) VOLTAGE APPLICATION WAVEFORM AT INPUT PIN: Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between VIL (MAX) and VIH (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between VIL (MAX) and VIH (MIN).

(2) HANDLING OF UNUSED INPUT PINS: Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

(3) PRECAUTION AGAINST ESD: A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

(4) STATUS BEFORE INITIALIZATION: Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

(5) POWER ON/OFF SEQUENCE: In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current. The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

(6) INPUT OF SIGNAL DURING POWER OFF STATE : Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.